

L Number	Hits	Search Text	DB	Time stamp
-	144	system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array)	USPAT; US-PGPUB	2004/05/28 09:56
-	2	(system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array)) and screen adj pad\$2	USPAT; US-PGPUB	2004/05/28 09:56
-	4	screen adj pad and (printed adj circuit adj board 'PCB' grid near5 array aluminum near2 frame) and (interconnect packaging magnetically near5 align\$3)	USPAT; US-PGPUB	2004/05/28 09:57
-	18	system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array) and magnet\$7 near5 align\$3 and conductive near5 interconnect	USPAT; US-PGPUB	2004/05/28 09:58
-	37	(system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array)) and (particle grain) near2 (size nano nanosize micron ultra\$2fine) and (acicular near5 shape (length width aspect diameter) near2 ratio)	USPAT; US-PGPUB	2004/05/28 09:59
-	31	(system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array)) and (weight wt) near2 (ratio part '%')	USPAT; US-PGPUB	2004/05/28 10:00
-	19	(system and substrate and ((polymer resin) and (magnetic ferro\$2magnetic titanate barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite)) same (interconnect\$4 coupling adj component packaging) and (print\$6 adj circuit adj board 'PCB' aluminum near2 frame grid near2 array)) and (photo\$2resist) and (thermal adj expansion)	USPAT; US-PGPUB	2004/05/28 10:00
-	24	((polymer thermoplastic thermoset photo\$2resist DNQ\$4 diazonaphthoquinone novolac epoxy polyamide) and (magnetic ferro\$2magnetic titanate iron magnetite barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite) and (particle powder fiber grain) near5 align\$4 near5 magnetic) and conductive near5 interconnect	USPAT; US-PGPUB	2004/05/28 10:00
-	10	(epoxy polyamide) and (magnetic ferro\$2magnetic titanate iron magnetite barium adj strontium adj titanate strontium adj tantalum adj oxide perovskite) and (particle powder fiber grain) near5 align\$4 near5 magnetic and conductive near5 interconnect	USPAT; US-PGPUB	2004/05/28 10:00
-	18	(((polymer thermoplastic thermoset polyamide epoxy photo\$2resist DNQ\$4 diazonaphthoquinone novolac) and (magnetic ferro\$2magnetic titanate iron magnetite perovskite)) and (particle powder fiber grain) near5 align\$4) and (conductive interconnect\$4 packag\$4)	EPO; JPO; DERWENT; IBM_TDB	2004/05/28 10:01
-	38	"5232661" "5536908" "5526978" "09023049"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/28 10:01